

ISL9R460P2, ISL9R460S2, ISL9R460S3S

4A, 600V Stealth™ Diode

General Description

The ISL9R460P2, ISL9R460S2 and ISL9R460S3S are Stealth™ diodes optimized for low loss performance in high frequency hard switched applications. The Stealth™ family exhibits low reverse recovery current (I_{RRM}) and exceptionally soft recovery under typical operating conditions.

This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I_{RRM} and short t_a phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the Stealth $^{\text{TM}}$ diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.

Formerly developmental type TA49408.

Features

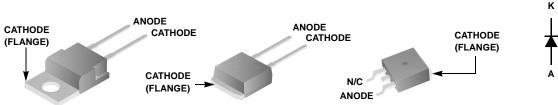
•	Soft Recovery $t_b / t_a > 3$
•	Fast Recovery t_{rr} < 20ns
•	Operating Temperature 175°C
•	Reverse Voltage 600V

Avalanche Energy Rated

Applications

- · Switch Mode Power Supplies
- · Hard Switched PFC Boost Diode
- · UPS Free Wheeling Diode
- · Motor Drive FWD
- SMPS FWD
- · Snubber Diode

JEDEC TO-220AC JEDEC STYLE TO-262 JEDEC TO-263AB



Device Maximum Ratings T_C= 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{RRM}	Peak Repetitive Reverse Voltage	600	V
V_{RWM}	Working Peak Reverse Voltage	600	V
V _R	DC Blocking Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current (T _C = 155°C)	4	А
I _{FRM}	Repetitive Peak Surge Current (20kHz Square Wave)	8	А
I _{FSM}	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60Hz)	50	А
P _D	Power Dissipation	58	W
E _{AVL}	Avalanche Energy (0.5A, 80mH)	10	mJ
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to 175	°C
TL	Maximum Temperature for Soldering		
T_{PKG}	Leads at 0.063in (1.6mm) from Case for 10s	300	°C
	Package Body for 10s, See Techbrief TB334	260	°C

CAUTION: Stresses above those listed in "Device Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

A/µs

500

Package Marking and Ordering Information

Device Marking	Device	Package	Tape Width	Quantity
R460P2	ISL9R460P2	TO-220AC	N/A	50
R460S2	ISL9R460S2	TO-262	N/A	50
R460S3S	ISL9R460S3S	TO-263AB	N/A	50
R460S3S	ISL9R460S3ST	TO-263AB	24mm	800

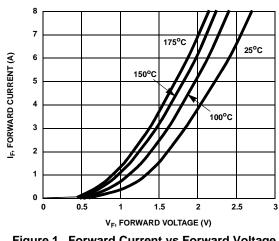
Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Off State	Characteristics						
I _R	Instantaneous Reverse Current	V _R = 600V	T _C = 25°C	-	-	100	μΑ
			T _C = 125°C	-	-	1.0	mA
On State	Characteristics						
V _F	Instantaneous Forward Voltage	I _F = 4A	T _C = 25°C	-	2.0	2.4	V
			T _C = 125°C	-	1.6	2.0	V
-	Characteristics	Tv. 40V.L.	20	1	10	ı	l
СЈ	Junction Capacitance	$V_R = 10V, I_F = 0$)A	-	19	-	pF
Switchin	g Characteristics						
t _{rr}	Reverse Recovery Time		$= 100 \text{A}/\mu \text{s}, V_{\text{R}} = 30 \text{V}$	-	17	20	ns
		$I_F = 4A$, $d_{IF}/dt = 100A/\mu s$, $V_R = 30V$		-	19	22	ns
t _{rr}	Reverse Recovery Time	$I_F = 4A,$ $d_{IF}/dt = 200A/\mu s,$ $V_R = 390V, T_C = 25^{\circ}C$		-	17	-	ns
I_{RRM}	Maximum Reverse Recovery Current			-	2.6	-	Α
Q_{RR}	Reverse Recovery Charge			-	22	-	nC
t _{rr}	Reverse Recovery Time	$I_F = 4A,$ $d_{IF}/dt = 200A/\mu s,$ $V_R = 390V,$ $T_C = 125^{\circ}C$		-	77	-	ns
S	Softness Factor (t _b /t _a)			-	4.2	-	
I _{RRM}	Maximum Reverse Recovery Current			-	2.8	-	Α
Q _{RR}	Reverse Recovery Charge			-	100	-	nC
t _{rr}	Reverse Recovery Time	I _F = 4A,		-	54	-	ns
S	Softness Factor (t _b /t _a)	$d_{IF}/dt = 400A/\mu$	S,	-	3.5	-	
I _{RRM}	Maximum Reverse Recovery Current	$V_R = 390V,$ $T_C = 125^{\circ}C$		-	4.3	-	Α
Q _{RR}	Reverse Recovery Charge				110	-	nC

Thermal Characteristics

 Q_{RR} dl_M/dt

Maximum di/dt during tb

$R_{\theta JC}$	Thermal Resistance Junction to Case		-	-	2.6	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	TO-220	-	-	62	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	TO-262	-	-	62	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	TO-263			62	°C/W



Typical Performance Curves

Figure 1. Forward Current vs Forward Voltage

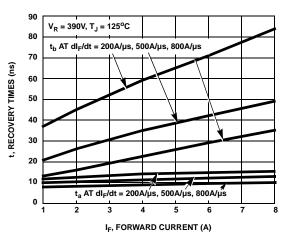


Figure 3. t_a and t_b Curves vs Forward Current

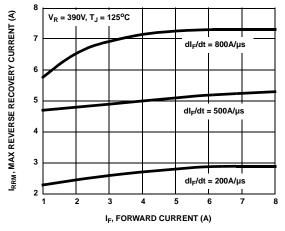


Figure 5. Maximum Reverse Recovery Current vs **Forward Current**

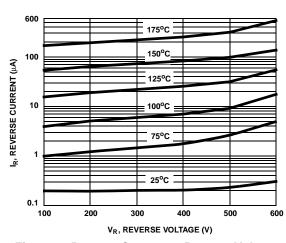


Figure 2. Reverse Current vs Reverse Voltage

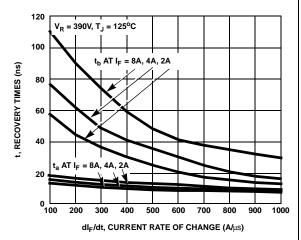


Figure 4. t_a and t_b Curves vs dI_F/dt

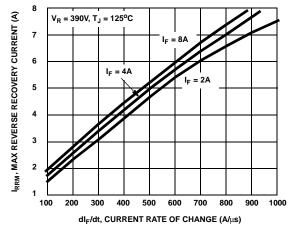


Figure 6. Maximum Reverse Recovery Current vs dl_F/dt